

NB7V585M

1.8V / 2.5V Differential 2:1 Mux Input to 1:6 CML Clock/Data Fanout Buffer/Translator Multi-Level Inputs w/ Internal Termination

Description

The NB7V585M is a differential 1-to-6 CML clock/data distribution chip featuring a 2:1 Clock/Data input multiplexer with an input select pin. The IN_x/\overline{IN}_x inputs incorporate internal $50\ \Omega$ termination resistors and will accept LVPECL, CML, or LVDS logic levels (see Figure 9). The NB7V585M produces six identical output copies of clock or data operating up to 6 GHz or 10 Gb/s, respectively. As such, NB7V585M is ideal for SONET, GigE, Fiber Channel, Backplane and other clock/data distribution applications. The 16 mA differential CML output structure provides matching internal $50\ \Omega$ source terminations, 400 mV output swings when externally terminated with a $50\ \Omega$ resistor to V_{CC} (see Figure 14) and is optimized for low skew and minimal jitter. The NB7V585M is powered with either 1.8 V or 2.5 V supply and is offered in a low profile 5x5 mm 32-pin QFN package.

Application notes, models, and support documentation are available at www.onsemi.com.

The NB7V585M is a member of the GigaComm™ family of high performance clock products.

Features

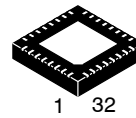
- Maximum Input Data Rate > 10 Gb/s
- Data Dependent Jitter < 10 ps
- Maximum Input Clock Frequency > 6 GHz
- Random Clock Jitter < 0.8 ps RMS, Max
- Low Skew 1:6 CML Outputs, 20 ps Max
- 2:1 Multi-Level Mux Inputs
- 175 ps Typical Propagation Delay
- 50 ps Typical Rise and Fall Times
- Differential CML Outputs, 330 mV Peak-to-Peak, Typical
- Operating Range: $V_{CC} = 1.71\text{ V to }1.89\text{ V}$
- Internal $50\ \Omega$ Input Termination Resistors
- V_{REFAC} Reference Output
- QFN32 Package, 5 mm x 5 mm
- $-40^\circ\text{C to }+85^\circ\text{C}$ Ambient Operating Temperature
- These are Pb-Free Devices



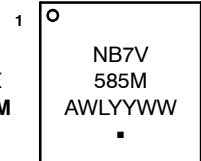
ON Semiconductor®

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MARKING DIAGRAM*



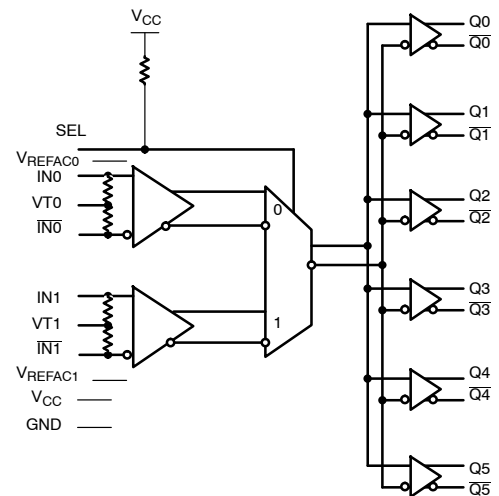
QFN32
MN SUFFIX
CASE 488AM



A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
■ = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

SIMPLIFIED LOGIC DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

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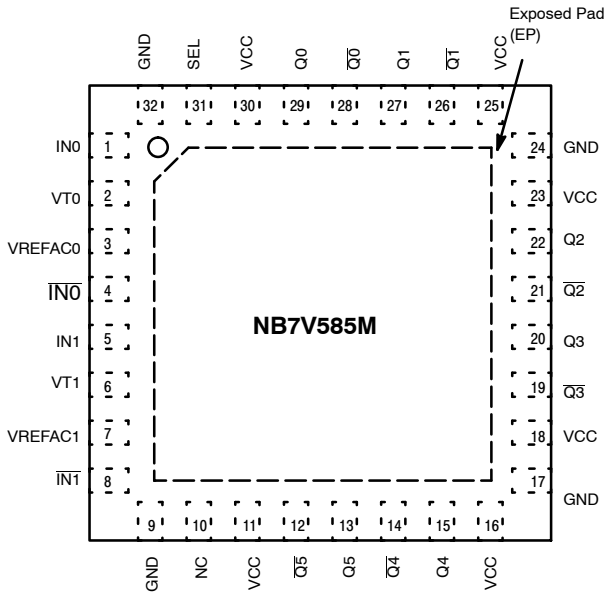


Figure 1. 32-Lead QFN Pinout (Top View)

Table 1. INPUT SELECT FUNCTION TABLE

SEL*	CLK Input Selected
0	IN0
1	IN1

*Defaults HIGH when left open.

Table 2. PIN DESCRIPTION

Pin	Name	I/O	Description
1,4 5,8	IN0, $\overline{\text{IN0}}$ IN1, $\overline{\text{IN1}}$	LVPECL, CML, LVDS Input	Non-inverted, Inverted, Differential Inputs
2,6	VT0, VT1		Internal 100 Ω Center-tapped Termination Pin for IN0/ $\overline{\text{IN0}}$ and IN1/ $\overline{\text{IN1}}$
31	SEL	LVTTTL/LVCMOS Input	Input Select pin; LOW for IN0 Inputs, HIGH for IN1 Inputs; defaults HIGH when left open
10	NC	–	No Connect
11, 16, 18 23, 25, 30	VCC	–	Positive Supply Voltage.
29, 28 27, 26	Q0, $\overline{\text{Q0}}$ Q1, $\overline{\text{Q1}}$	CML Output	Non-inverted, Inverted Differential Outputs (Note 1).
22, 21 20, 19	Q2, $\overline{\text{Q2}}$ Q3, $\overline{\text{Q3}}$	CML Output	Non-inverted, Inverted Differential Outputs (Note 1).
15, 14 13, 12	Q4, $\overline{\text{Q4}}$ Q5, $\overline{\text{Q5}}$	CML Output	Non-inverted, Inverted Differential Outputs (Note 1).
9, 17, 24, 32	GND		Negative Supply Voltage, connected to Ground
3 7	VREFAC0 VREFAC1	–	Output Voltage Reference for Capacitor-Coupled Inputs, only
–	EP	–	The Exposed Pad (EP) on the QFN-32 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is electrically connected to the die, and must be electrically and thermally connected to GND on the PC board.

1. In the differential configuration when the input termination pins (VT0, VT1) are connected to a common termination voltage or left open, and if no signal is applied on INn/ $\overline{\text{INn}}$ input, then, the device will be susceptible to self-oscillation. Qn/ $\overline{\text{Qn}}$ outputs have internal 50 Ω source termination resistors.
2. All VCC and GND pins must be externally connected to a power supply for proper operation.

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Table 3. ATTRIBUTES

Characteristics		Value
ESD Protection	Human Body Model Machine Model	> 4 kV > 200 V
Input Pullup Resistor (R _{PU})		75 kΩ
Moisture Sensitivity (Note 3)		Level 1
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in
Transistor Count		308
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test		

3. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Positive Power Supply	GND = 0 V		3.0	V
V _{IO}	Input/Output Voltage	GND = 0 V	-0.5 ≤ V _{IO} ≤ V _{CC} + 0.5	-0.5 to V _{CC} + 0.5	V
V _{INPP}	Differential Input Voltage I _{Nx} - I _{Nx}			1.89	V
I _{IN}	Input Current Through R _T (50 Ω Resistor)			± 40	mA
I _{OUT}	Output Current	Continuous Surge		34 40	mA
I _{VFREFAC}	V _{REFAC} Sink/Source Current			± 1.5	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ _{JA}	Thermal Resistance (Junction-to-Ambient) (Note 4)	0 lfpm 500 lfpm	QFN-32 QFN-32	31 27	°C/W °C/W
θ _{JC}	Thermal Resistance (Junction-to-Case) (Note 4)	Standard Board	QFN-32	12	°C/W
T _{sol}	Wave Solder Pb-Free			265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

4. JEDEC standard multilayer board – 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

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Table 5. DC CHARACTERISTICS – CML OUTPUT $V_{CC} = 1.8\text{ V} \pm 5\%$ or $2.5\text{ V} \pm 5\%$, $GND = 0\text{ V}$, $T_A = -40^\circ\text{C}$ to 85°C (Note 5)

Symbol	Characteristic	Min	Typ	Max	Unit
POWER SUPPLY CURRENT					
I_{CC}	Power Supply Current (Inputs and Outputs Open) $V_{CC} = 2.65\text{ V}$ $V_{CC} = 1.89\text{ V}$		235 210	260	mA
CML OUTPUTS (Note 6)					
V_{OH}	Output HIGH Voltage $V_{CC} = 2.5\text{ V}$ $V_{CC} = 1.8\text{ V}$	$V_{CC} - 40$ 2460 1760	$V_{CC} - 20$ 2480 1780	V_{CC} 2500 1800	mV
V_{OL}	Output LOW Voltage $V_{CC} = 2.5\text{ V}$ $V_{CC} = 1.8\text{ V}$	$V_{CC} - 500$ 2000 1300	$V_{CC} - 400$ 2100 1400	$V_{CC} - 275$ 2200 1500	mV
DIFFERENTIAL INPUTS DRIVEN SINGLE-ENDED (Note 7) (Figure 6)					
V_{th}	Input Threshold Reference Voltage Range (Note 8)	1050		$V_{CC} - 100$	mV
V_{IH}	Single-Ended Input HIGH Voltage	$V_{th} + 100$		V_{CC}	mV
V_{IL}	Single-Ended Input LOW Voltage	GND		$V_{th} - 100$	mV
V_{ISE}	Single-Ended Input Voltage ($V_{IH} - V_{IL}$)	200		1200	mV
V_{REFAC}					
V_{REFAC}	Output Reference Voltage @ 100 μA for Capacitor – Coupled Inputs, Only	$V_{CC} - 625$	$V_{CC} - 500$	$V_{CC} - 400$	mV
DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY (Note 9) (Figures 4 and 7)					
V_{IHD}	Differential Input HIGH Voltage (I_N, \bar{I}_N)	1100		V_{CC}	mV
V_{ILD}	Differential Input LOW Voltage (I_N, \bar{I}_N)	GND		$V_{CC} - 100$	mV
V_{ID}	Differential Input Voltage (I_N, \bar{I}_N) ($V_{IHD} - V_{ILD}$)	100		1200	mV
V_{CMR}	Input Common Mode Range (Differential Configuration, Note 10) (Figure 9)	1050		$V_{CC} - 50$	mV
I_{IH}	Input HIGH Current I_N/\bar{I}_N (V_{TO} / V_{T1} Open)	-150		150	μA
I_{IL}	Input LOW Current I_N/\bar{I}_N (V_{TO} / V_{T1} Open)	-150		150	μA
CONTROL INPUT (SEL Pin)					
V_{IH}	Input HIGH Voltage for Control Pin	$V_{CC} \times 0.65$		V_{CC}	mV
V_{IL}	Input LOW Voltage for Control Pin	GND		$V_{CC} \times 0.35$	mV
I_{IH}	Input HIGH Current	-150	20	+150	μA
I_{IL}	Input LOW Current	-150	5	+150	μA
TERMINATION RESISTORS					
R_{TIN}	Internal Input Termination Resistor (Measured from I_N to V_{Tx})	45	50	55	Ω
R_{TOUT}	Internal Output Termination Resistor	45	50	55	Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- Input and output parameters vary 1:1 with V_{CC} .
- CML outputs (Q_n/\bar{Q}_n) have internal 50 Ω source termination resistors and must be externally terminated with 50 Ω to V_{CC0} for proper operation.
- V_{th} , V_{IH} , V_{IL} and V_{ISE} parameters must be complied with simultaneously.
- V_{th} is applied to the complementary input when operating in single-ended mode.
- V_{IHD} , V_{ILD} , V_{ID} and V_{CMR} parameters must be complied with simultaneously.
- V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC} . The V_{CMR} range is referenced to the most positive side of the differential input signal.

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Table 6. AC CHARACTERISTICS $V_{CC} = 1.8\text{ V} \pm 5\%$ or $2.5\text{ V} \pm 5\%$, $GND = 0\text{ V}$, $T_A = -40^\circ\text{C}$ to 85°C (Note 11)

Symbol	Characteristic	Min	Typ	Max	Unit
f_{MAX}	Maximum Input Clock Frequency, $V_{OUTPP} \geq 200\text{ mV}$	6.0	7.0		GHz
$f_{DATAMAX}$	Maximum Operating Input Data Rate (PRBS23)	10			Gbps
V_{OUTPP}	Output Voltage Amplitude (See Figures 4, Note 15) $f_{in} \leq 4.0\text{ GHz}$ $f_{in} \leq 6.0\text{ GHz}$	250 200	400 325		mV
t_{PLH}, t_{PHL}	Propagation Delay to Output Differential @ 1 GHz, Measured at Differential Crosspoint IN_x/IN_x^- to Q_n/Q_n^- SEL to Q_n	125	175 200	250 300	ps
$t_{PLH\ TC}$	Propagation Delay Temperature Coefficient		100		fs/ $^\circ\text{C}$
t_{SKEW}	Output – Output Skew (Within Device) (Note 12) Device – Device Skew ($t_{pd\ Max} - t_{pd\ min}$)			30 50	ps
t_{DC}	Output Clock Duty Cycle (Reference Duty Cycle = 50%) $f_{in} \leq 4.0\text{ GHz}$	45	50	55	%
t_{JITTER}	Output Random Jitter (RJ) (Note 13) Deterministic Jitter (DJ) (Note 14) $f_{in} \leq 6.0\text{ GHz}$ $f_{in} \leq 10\text{ Gbps}$		0.2	0.8 10	ps rms ps pk-pk
V_{INPP}	Input Voltage Swing (Differential Configuration) (Note 15)	100		1200	mV
t_r, t_f	Output Rise/Fall Times @ 1 GHz (20% – 80%) $Q_n, \overline{Q_n}$		50	65	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

11. Measured using a 400 mV source, 50% duty cycle clock source. All outputs must be loaded with external 50 Ω to V_{CC} . Input edge rates 40 ps (20% – 80%).
12. Skew is measured between outputs under identical transitions and conditions. Duty cycle skew is defined only for differential operation when the delays are measured from cross-point of the inputs to the crosspoint of the outputs.
13. Additive RMS jitter with 50% duty cycle clock signal.
14. Additive Peak-to-Peak data dependent jitter with input NRZ data at PRBS23.
15. Input and output voltage swing is a single-ended measurement operating in differential mode.

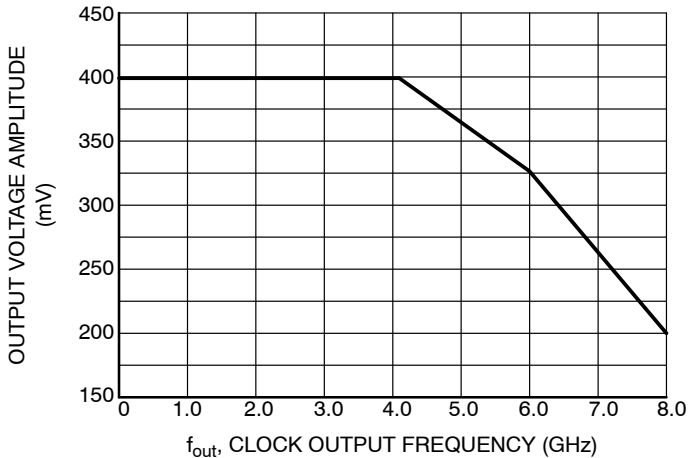


Figure 2. Output Voltage Amplitude (V_{OUTPP}) vs. Input Frequency (f_{in}) at Ambient Temperature (Typical)

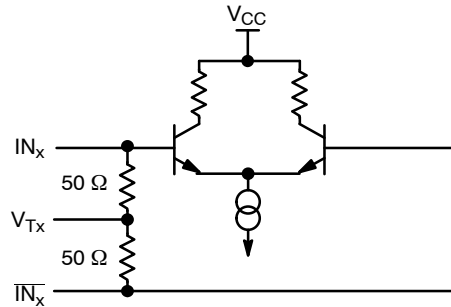


Figure 3. Input Structure

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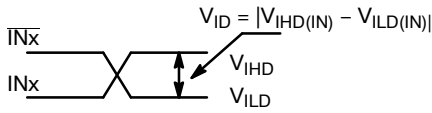


Figure 4. Differential Inputs Driven Differentially

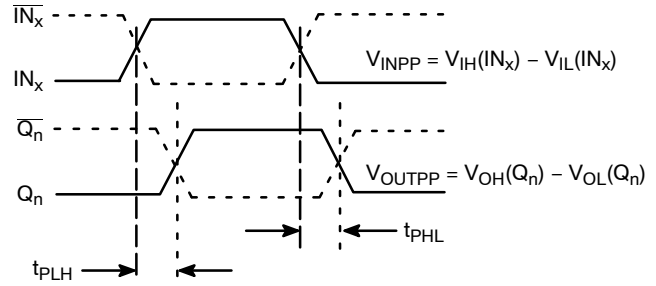


Figure 5. AC Reference Measurement

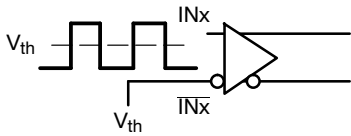


Figure 6. Differential Input Driven Single-Ended

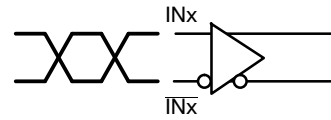


Figure 7. Differential Inputs Driven Differentially

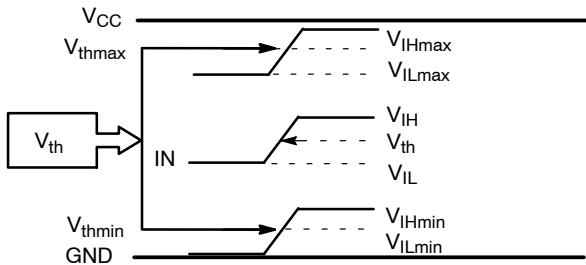


Figure 8. V_{th} Diagram

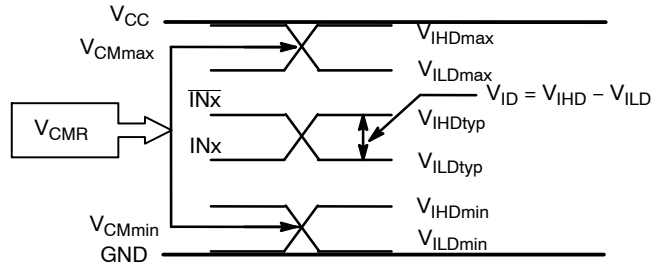


Figure 9. V_{CMR} Diagram

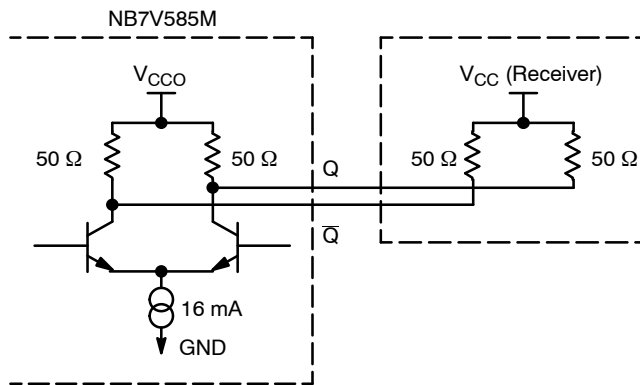


Figure 10. Typical CML Output Structure and Termination

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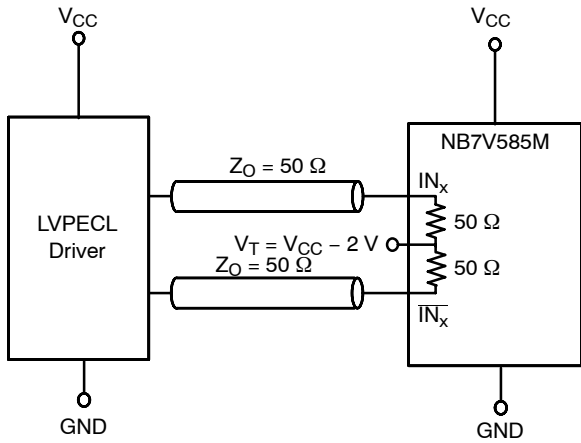


Figure 11. LVPECL Interface

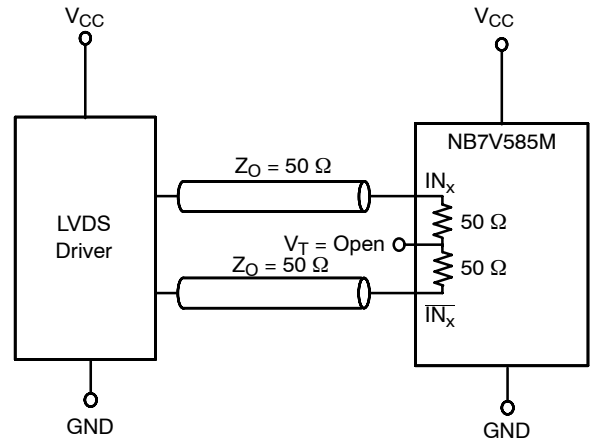


Figure 12. LVDS Interface

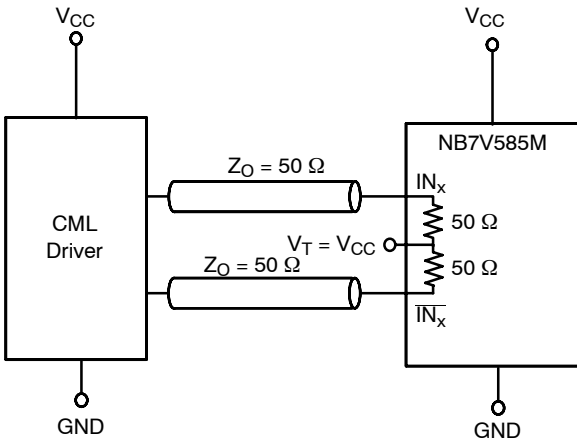


Figure 13. Standard 50 Ω Load CML Interface

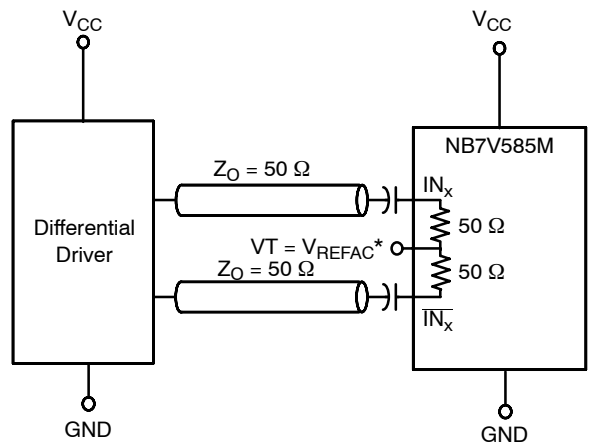


Figure 14. Capacitor-Coupled Differential Interface
(V_T Connected to V_{REFAC})

* V_{REFAC} bypassed to ground with a 0.01 μ F capacitor

ORDERING INFORMATION

Device	Package	Shipping [†]
NB7V585MMNG	QFN32 (Pb-Free)	74 Units / Rail
NB7V585MMNR4G	QFN32 (Pb-Free)	1000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
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